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10-bit bus switch with 5-bit output enables Rev. 06 — 2 November 2009

Product data sheet

General description 1.

The CBT3384 provides ten bits of high-speed TTL-compatible bus switching. The low ON resistance of the switch allows connections to be made with minimal propagation delay.

The CBT3384 device is organized as two 5-bit bus switches with two separate output enable $(1\overline{OE}, 2\overline{OE})$ inputs. When $n\overline{OE}$ is LOW, the switch is on and port A is connected to the B port. When $n\overline{OE}$ is HIGH, each switch is disabled.

The CBT3384 is characterized for operation from -40 °C to +85 °C.

Features 2.

- **5** Ω switch connection between two ports
- TTL-compatible control input levels
- Multiple package options
- See CBTD3384 for CBT3384 with level shifting diodes
- Latch-up protection exceeds 100 mA per JESD78
- **ESD** protection:
 - HBM JESD22-A114E exceeds 2000 V
 - CDM JESD22-C101C exceeds 1000 V

Ordering information 3.

Table 1. Or	able 1. Ordering information								
Туре	Package	Package							
number	Temperature range	Name	Description	Version					
CBT3384D	–40 °C to +85 °C	SO24	plastic small outline package; 24 leads; body width 7.5 mm	SOT137-1					
CBT3384DB	–40 °C to +85 °C	SSOP24	plastic shrink small outline package; 24 leads; body width 5.3 mm	SOT340-1					
CBT3384DK	–40 °C to +85 °C	SSOP24[1]	plastic shrink small outline package; 24 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT556-1					
CBT3384PW	–40 °C to +85 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1					

[1] Also known as QSOP24 package



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4. Functional diagram



5. Pinning information

5.1 Pinning



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5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
$1\overline{OE}, 2\overline{OE}$	1, 13	output enable input (active LOW)
1A1 to 1A5	5 3, 4, 7, 8, 11	data input/output (A port)
2A1 to 2A5	5 14, 17, 18, 21, 22	data input/output (A port)
1B1 to 1B5	2, 5, 6, 9, 10	data input/output (B port)
2B1 to 2B5	5 15, 16, 19, 20, 23	data input/output (B port)
GND	12	ground (0 V)
V _{CC}	24	positive supply voltage

6. Functional description

Table 3. Function selection	n <u>[1]</u>		
Input		Input/output	
1 <mark>0E</mark>	2 0E	1An, 1Bn	2An, 2Bn
L	L	1An = 1Bn	2An = 2Bn
L	Н	1An = 1Bn	Z
Н	L	Z	2An = 2Bn
Н	Н	Z	Z

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).^[1] $T_{amb} = -40 \degree C$ to +85 $\degree C$, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
VI	input voltage		[2] -0.5	+7.0	V
I _O	output current	V _O < 0 V	-	±128	mA
I _{IK}	input clamping current	$V_{I/O} = 0 V$	-50	-	mA
T _{stg}	storage temperature		-65	+150	°C

 Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under <u>Section 8</u>, is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[2] The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

8. Recommended operating conditions

Table 5.Operating conditions

All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		4.5	-	5.5	V
VIH	HIGH-state input voltage		2.0	-	-	V
VIL	LOW-state input voltage		-	-	0.8	V
T _{amb}	ambient temperature	operating in free air	-40	-	+85	°C

9. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T _{amb} =	T _{amb} = −40 °C to +85 °C		
			Min	Typ[1]	Max	
V _{IK}	input clamping voltage	$V_{CC} = 4.5 \text{ V}; \text{ I}_{I} = -18 \text{ mA}$	-	-	-1.2	V
lı	input leakage current	V_{CC} = 5.5 V; V_{I} = GND or 5.5 V	-	-	±1	μΑ
I _{CC}	supply current	V_{CC} = 5.5 V; I _O = 0 mA; V _I = V _{CC} or GND	-	-	3	μA
ΔI_{CC}	additional supply current	per input pin; $V_{CC} = 5.5$ V; one input at [2] 3.4 V, other inputs at V_{CC} or GND	-	-	2.5	mA
V _{pass}	pass voltage	output HIGH; V _I = V _{CC} = 5.0 V; $I_O = -100 \ \mu A$	3.6	3.9	4.2	V
CI	input capacitance	control pins; $V_I = 3 V \text{ or } 0 V$	-	4.0	-	pF
C _{io(off)}	off-state input/output capacitance	port off; $V_1 = 3 V \text{ or } 0 V$; $n\overline{OE} = V_{CC}$	-	10.0	-	pF

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Voltages a	re referenced to GND (groui	nd = 0 V).						
Symbol Parameter Conditions		Conditions	ions		T _{amb} = −40 °C to +85 °C			Unit
				Min	Typ <mark>[1]</mark>	Max		
R _{ON}	ON resistance	$V_{CC} = 4.5 \text{ V}; \text{ V}_{I} = 0 \text{ V}; \text{ I}_{I} = 64 \text{ mA}$	[3]	-	5	7	Ω	
		$V_{CC} = 4.5 \text{ V}; \text{ V}_{I} = 0 \text{ V}; \text{ I}_{I} = 30 \text{ mA}$	<u>[3]</u>	-	5	7	Ω	
		V_{CC} = 4.5 V; V_{I} = 2.4 V; I_{I} = -15 mA	[3]	-	10	15	Ω	

 Table 6.
 Static characteristics ... continued

[1] All typical values are at $V_{CC} = 5 \text{ V}$, $T_{amb} = 25 \text{ °C}$.

[2] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

[3] Measured by the voltage drop between the nAn and the nBn terminals at the indicated current through the switch. ON resistance is determined by the lowest voltage of the two (nAn or nBn) terminals.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions	Ta	T _{amb} = 25 °C			$T_{amb} = -40 \ ^{\circ}C \text{ to } +85 \ ^{\circ}C \text{ Ur}$		
			Min	Тур	Max	Min	Max		
t _{pd}	propagation delay	nAn, nBn to nBn, nAn; [1][2] see Figure 5							
		$V_{CC}=5.0~V\pm0.5~V$	-	-	0.25	-	0.25	ns	
t _{PZH}	OFF-state to HIGH propagation delay	nOE to nAn or nBn; see <u>Figure 6</u>							
		$V_{CC}=5.0~V\pm0.5~V$	1.2	2.3	5.7	1.2	5.6	ns	
t _{PZL}	OFF-state to LOW propagation delay	nOE to nAn or nBn; see <u>Figure 6</u>							
		$V_{CC}=5.0~V\pm0.5~V$	1.2	2.3	5.7	1.2	6.0	ns	
t _{PHZ}	HIGH to OFF-state propagation delay	nOE to nAn or nBn; see <u>Figure 6</u>							
		$V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$	1.7	3.6	5.2	1.7	5.5	ns	
t _{PLZ}	LOW to OFF-state propagation delay	nOE to nAn or nBn; see <u>Figure 6</u>							
		V_{CC} = 5.0 V ± 0.5 V	1.7	2.7	5.2	1.7	6.6	ns	

[1] The propagation delay is the calculated RC time constant of the typical ON resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

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11. Waveforms





Table 8. Measurement points

Supply voltage Input		Output				
V _{CC}	VI	V _M	V _M	V _X	V _Y	
V_{CC} = 5.0 V \pm 0.5 V	GND to 3.0 V	1.5 V	1.5 V	V _{OL} + 0.3 V	$V_{OH} - 0.3 \ V$	

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12. Test information



Table 9. Test data

Supply voltage	Input		Load		V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}
V_{CC} = 5.0 V \pm 0.5 V	GND to 3.0 V	\leq 2.5 ns	50 pF	500 Ω	open	7.0 V	open

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13. Package outline



Fig 8. Package outline SOT137-1 (SO24)

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Fig 9. Package outline SOT340-1 (SSOP24)





Fig 10. Package outline SOT556-1 (SSOP24)

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Fig 11. Package outline SOT355-1 (TSSOP24)

14. Abbreviations

Table 10. Abbreviat	ions
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
FET	Field Effect Transistor
НВМ	Human Body Model
PRR	Pulse Rate Repetition
TTL	Transistor-Transistor Logic

15. Revision history

Table 11. Revision history **Document ID Release date** Data sheet status **Change notice** Supersedes CBT3384_6 20091102 Product data sheet CBT3384_5 • The format of this data sheet has been redesigned to comply with the new identity guidelines of Modifications: NXP Semiconductors. • Legal texts have been adapted to the new company name where appropriate. • Changed: Table 6 "Static characteristics" a. Pass voltage values have changed. b. Undershoot static current protection removed. • Changed: Table 7 "Dynamic characteristics" a. Enable and disable times values have changed. CBT3384_5 20011220 Product specification -CBT3384_4 CBT3384 4 20010319 Product specification CBT3384 3 -20001113 Product specification CBT3384_3 CBT3384_2 -CBT3384_2 20000128 Product specification --

16. Legal information

16.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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